

C2225X103KHRACTU

Aliases (C2225X103KHRAC7800) SMD Comm X7R HV Flex, Ceramic, 0.01 uF, 10%, 3,000 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 2225, 3.2 mm



Click here for the 3D model.

2225

5.9mm +/-0.75mm

General Information	
Series	SMD Comm X7R HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	430 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	0.01 uF
l i i i i i i i i i i i i i i i i i i i	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	10%
	Voltage DC	3000 VDC
	Dielectric Withstanding Voltage	3,600 VDC
ı	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
ic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
	Dissipation Factor	2.5%1kHz1.0Vrms
	Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours

Insulation Resistance

100 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Packaging Specifications	
В	0.7mm +/-0.35mm
S	3.2mm MIN
т	2mm +/-0.20mm
W	6.4mm +/-0.4mm

Packaging Specifications	
Packaging	T&R, 18

Dimensions

Packaging Quantity

Chip Size

L

80mm, Plastic 500